

Application Data Sheet

APPLICATION INFORMATION

Application Number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Number of CD Disks:

Number of Copies of CDs::

Sequence Submission?::

Computer Readable From (CRF)?:: No

Number of Copies of CRF::

Title:: SEMICONDUCTOR DEVICE AND
MANUFACTURING METHOD THEREOF

Attorney Docket Number:: 403031

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 24

Small Entity?:: No

Latin Name::

Variety denomination name::

Petition Included?:: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Appl.?:: No

APPLICANT INFORMATION

Applicant Authority Type:: Inventor
Primary Citizenship Country:: JP
Status:: Full Capacity
Given Name:: Shunichi
Middle Name::
Family Name:: ABE
Name Suffix::
City of Residence:: Hyogo
State or Prov. of Residence::
Country of Residence:: JP
Street of mailing address:: c/o Mitsubishi Denki Kabushiki Kaisha,
2-3, Marunouchi 2-chome, Chiyoda-ku
City of mailing address:: Tokyo
State or Province of mailing address::
Country of mailing address:: JP
Postal or Zip Code of mailing address:: 100-8310

Applicant Authority Type:: Inventor
Primary Citizenship Country:: JP
Status:: Full Capacity
Given Name:: Tetsuya
Middle Name::
Family Name:: UEBAYASHI
Name Suffix::
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State or Prov. of Residence::
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City of mailing address:: Tokyo
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Applicant Authority Type:: Inventor
Primary Citizenship Country:: JP
Status:: Full Capacity
Given Name:: Naoki
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Family Name:: IZUMI
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City of mailing address:: Tokyo
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Applicant Authority Type:: Inventor
Primary Citizenship Country:: JP
Status:: Full Capacity
Given Name:: Akira
Middle Name::
Family Name:: YAMAZAKI
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CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 23548
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REPRESENTATIVE INFORMATION

Representative Customer Number:: 23548

Representative Designation:: Registration Number:: Representative Name::

DOMESTIC PRIORITY INFORMATION

Application:: Continuity Type:: Parent Application:: Parent Filing Date::
This Application Division of 10/892,539 6/28/2001

FOREIGN APPLICATION INFORMATION

Country::	Application Number::	Filing Date::	Priority Claimed
JP	2001-032362	2/8/2001	Yes

ASSIGNEE INFORMATION

Assignee name:: Renesas Technology Corp.

Street of mailing address:: 4-1, Marunouchi 2-chome,
Chiyoda-ku

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Country of mailing
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